

Receipt #2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**COPY OF PAPERS
ORIGINALLY FILED**

Patent application of:

Hiroto OHTAKE et al

Appln. No.: 10/080,848

Art Unit: 2814

Filed: February 22, 2002

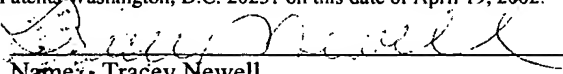
Examiner: To be Assigned

For: **METHOD OF MANUFACTURING A
SEMICONDUCTOR DEVICE CAPABLE
OF ETCHING A MULTI-LAYER OF
ORGANIC FILMS AT A HIGH
SELECTIVITY**

Docket No.: KRM-00101

Certificate of Mailing

I hereby certify that the foregoing documents are being deposited with the United States Postal Service as first class mail, in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 on this date of April 19, 2002.


Name: Tracey Newell

REQUEST FOR CORRECTION OF FILING RECEIPT

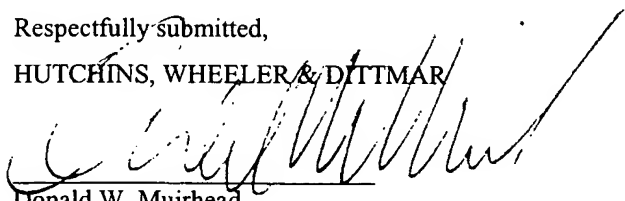
Customer Corrections Branch
Assistant Commissioner for Patents
Washington, DC 20231

Sir:

Enclosed is a copy of the Filing Receipt for the above-identified U.S. patent application as well as a copy of the originally-filed Declaration. Please correct the number of independent claims to be 9. The change is noted in red on the copy of the Filing Receipt.

Should there be any questions concerning this request, the Examiner is invited to contact the undersigned at (617) 951-6676.

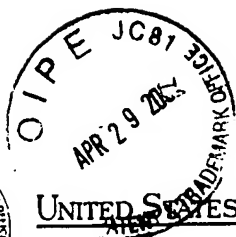
Respectfully submitted,
HUTCHINS, WHEELER & DITTMAR


Donald W. Muirhead
Reg. No. 33,978

April 19, 2002

Date

Patent Group
Hutchins, Wheeler & Dittmar
101 Federal Street
Boston, MA 02110



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
WWW.USPTO.GOV

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/080,848	02/22/2002	2814	1490	KRM-00101	25	29	109

CONFIRMATION NO. 9662

Patent Group
Hutchins, Wheeler & Dittmar
101 Federal Street
Boston, MA 02110

**COPY OF PAPERS
ORIGINALLY FILED**

FILING RECEIPT



OC000000007852336

Date Mailed: 04/11/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Hiroto Ohtake, Tokyo, JAPAN;
Shinobu Saitoh, Tokyo, JAPAN;
Munehiro Tada, Tokyo, JAPAN;
Yoshihiro Hayashi, Tokyo, JAPAN;

Assignment For Published Patent Application

NEC Corporation;

Domestic Priority data as claimed by applicant

Foreign Applications

JAPAN 047358/2001 02/22/2001

If Required, Foreign Filing License Granted 03/19/2002

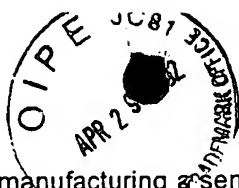
Projected Publication Date: 08/22/2002

Non-Publication Request: No

Early Publication Request: No

Title

Method of manufacturing a semiconductor device capable of etching a multi-layer of organic films at a high selectivity



**COPY OF PAPERS
ORIGINALLY FILED**

Preliminary Class

257

**LICENSE FOR FOREIGN FILING UNDER
Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

GRANTED

The applicant has been granted a license under 35 U.S.C. 184, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" followed by a date appears on this form. Such licenses are issued in all applications where the conditions for issuance of a license have been met, regardless of whether or not a license may be required as set forth in 37 CFR 5.15. The scope and limitations of this license are set forth in 37 CFR 5.15(a) unless an earlier license has been issued under 37 CFR 5.15(b). The license is subject to revocation upon written notification. The date indicated is the effective date of the license, unless an earlier license of similar scope has been granted under 37 CFR 5.13 or 5.14.

This license is to be retained by the licensee and may be used at any time on or after the effective date thereof unless it is revoked. This license is automatically transferred to any related applications(s) filed under 37 CFR 1.53(d). This license is not retroactive.

The grant of a license does not in any way lessen the responsibility of a licensee for the security of the subject matter as imposed by any Government contract or the provisions of existing laws relating to espionage and the national security or the export of technical data. Licensees should apprise themselves of current regulations especially with respect to certain countries, of other agencies, particularly the Office of Defense Trade Controls, Department of State (with respect to Arms, Munitions and Implements of War (22 CFR 121-128)); the Office of Export Administration, Department of Commerce (15 CFR 370.10 (j)); the Office of Foreign Assets Control, Department of Treasury (31 CFR Parts 500+) and the Department of Energy.

NOT GRANTED

No license under 35 U.S.C. 184 has been granted at this time, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" DOES NOT appear on this form. Applicant may still petition for a license under 37 CFR 5.12, if a license is desired before the expiration of 6 months from the filing date of the application. If 6 months has lapsed from the filing date of this application and the licensee has not received any indication of a secrecy order under 35 U.S.C. 181, the licensee may foreign file the application pursuant to 37 CFR 5.15(b).